AMP | Mark I

TE Internal #: 172037-1

PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 7 mm [.275 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder,

Natural, Mark I

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Connectors > PCB Connectors > PCB Headers & Receptacles











Connector System: Wire-to-Board

Number of Positions: 5

Centerline (Pitch): 7 mm [.275 in]

Sealable: No

PCB Mount Orientation: Vertical

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Header Type	Fully Shrouded
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	5
PCB Mount Orientation	Vertical
Number of Rows	2
Body Features	
Primary Product Color	Natural
Contact Features	
Contact Type	Tab

Tin (Sn)

Contact Mating Area Plating Material



Termination Features

Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	With
PCB Mount Alignment	With
PCB Mount Retention	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	7 mm[.275 in]
Usage Conditions	
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]
Packaging Features	
Packaging Method	Tray

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides



on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Mark I



Automotive Housings(2)



Automotive Terminals(4)



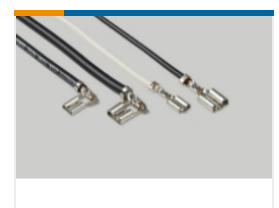
Crimp Terminal Housings(24)



Insertion & Extraction Tools(1)



PCB Headers & Receptacles(20)

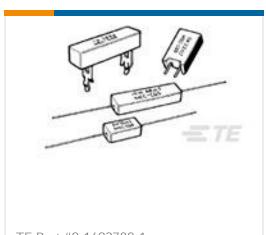


Quick Disconnects(29)

Customers Also Bought



Header Assembly: Wire-to-Board, 15A, gold or tin plated



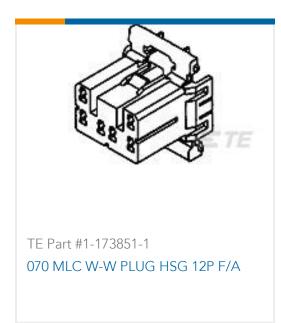
TE Part #2-1623788-1 SQM5 R10 5% (WIRE)

















Documents

CAD Files

Customer View Model

ENG_CVM_172037-1_E3.3d_igs.zip

English

Customer View Model

ENG_CVM_172037-1_E3.3d_stp.zip

English

Customer View Model

ENG_CVM_172037-1_E3.2d_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Multi-Interlock Mark II Connector for Printed Circuit Board

Japanese

Product Specification

Japanese

Multi-Interlock Mark II Connector for Wire to Board Termination

English

Product Specification

English

Instruction Sheets

Multi Interlock Connector Mark II

English

PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 7 mm [.275 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Natural, Mark I



Customer Manual (non U.S.)

English

Agency Approvals

Agency Approval Document

English